ASEDCIATION CONNECTING ELECTRONICS INDUSTRIES® International and Pa	IPC Bannockh	urn Illinois A	Il rights reserved untions.	inder both	This docume level parts, t	ent is a declaration entries the declaration entries and t	on of the su	bstances v all lower	vithin the manufactu level materials for v	rer listed	item. Note: if nanufacturer	the item is an as has engineering	sembly with low responsibility.	
				Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Information					on				
upplier Information														
Company name* Company u			unique ID			Unique ID Authority				Respon	Response Date*			
isemi										2024-04	2024-04-25			
ontact Name	tact Name Title - Contact					Phone - Contact*				Email - Contact*				
Product-Env-Stewards Product Enviro Con			o Compliance		NA				Product-Env-Stewards@onsemi.com					
Authorized Representative* Title - Representative			sentative	tative J		Phone - Representative*			Email - Representative*					
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Produe	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Item Number		umber Mfr Item Name			Effective Date	Version	ersion Manufacturing Site			Weight*	UOM	Unit Type	
	NCP282	ICP2820FCT1G ANA CLAS D AUD		UDIO AMP		2024-04-25	MYQ		IYQ		2.848052	mg	Each	
Ianufacturing Proccess Informa	ation		·									•		
Terminal Plating / Grid Array M	rid Array Material Terminal Base Alloy J-S			J-STD-020 MSI	Rating	g Peak Process Body Temperature Max Time at Peak				Temperature Number of Reflow Cycles				
SnAgCu CU Alloy			1		260		С	30	secoi	nds 3				
omments														
vel 1 - maximum time at peak temperat	ure during so	dering is 10-3	0 seconds											
or more information regarding materia	l composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Dibutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select select a RoHS exemption, if applic sigma range of distribution unless	able [E] enter the weight							
Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.853633	mg	Supplier	Silicon (Si)	7440-21-3		1.8536	mg
Protection coat	0.015447	mg		Polyimide	proprietary data		0.0154	mg
Solder Ball	0.941058	mg	Supplier	Silver (Ag)	7440-22-4		0.0245	mg
			Supplier	Tin (Sn)	7440-31-5		0.9109	mg
			Supplier	Copper (Cu)	7440-50-8		0.0056	mg
Under Bump Metal	0.037914	mg	Supplier	Titanium (Ti)	7440-32-6		0.0003	mg
		-	Supplier	Copper (Cu)	7440-50-8		0.0377	mg